

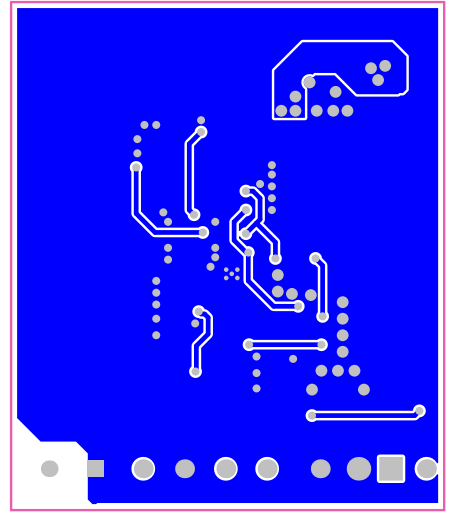
M1 Board Outline  
 Top Layer  
 M2 Board Dimensions

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

	BOARD #: PMP30104	REV:	SUN REV: Not In VersionControl
	TID #: .TID		
PLOT NAME = Top Copper	GENERATED : 7/27/2016	6:11:32 PM	TEXAS INSTRUMENTS

MI Board Outline

Bottom Layer



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